P54/74FCT377/A/C (P54/74PCT377/A/C)
OCTAL D FLIP-FLOP WITH CLOCK ENABLE

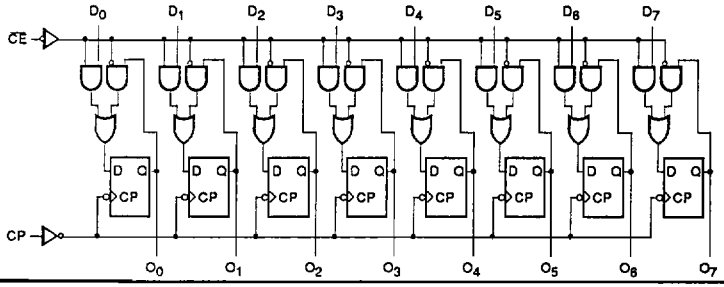
FEATURES

- Function, Pinout, and Drive Compatible with the FCT and F Logic
- FCT-C speed at 5.2ns max. (Com'l) FCT-A speed at 7.2ns max. (Com'l)
- CMOS V_{OH} Levels for Low Power Consumption — Typically 1/3 of FAST Bipolar Logic
- Edge-rate Control Circuitry for Significantly Improved Noise Characteristics
- ESD protection exceeds 2000V
- Inputs and Outputs Interface Directly with TTL, NMOS, and CMOS Devices
- Outputs Meet Levels Required for CMOS Static RAM Low Power Standby Mode
- 64 mA Sink Current (Com'l), 48 mA (Mil) 15 mA Source Current (Com'l), 12 mA (Mil)
- Clock Enable for Address and Data Synchronization Application
- Eight Edge-Triggered D Flip-Flops
- 3-State Output
- Manufactured in 0.8 micron PACE Technology™

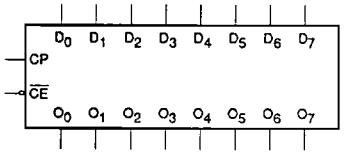
DESCRIPTION

The 'FCT377 has eight edge-triggered, D-type flip-flops with individual D inputs and O outputs. The common buffered clock (CP) input loads all flip-flops simultaneously when the Clock Enable ($\overline{CE}$) is LOW. The register is fully edge-triggered. The state of each D input one set-up time before the LOW-to-HIGH clock transition, is transferred to the corresponding flip-flop's O output. The $\overline{CE}$ input must be stable only one set-up time prior to the LOW-to-HIGH clock transition for predictable operation.

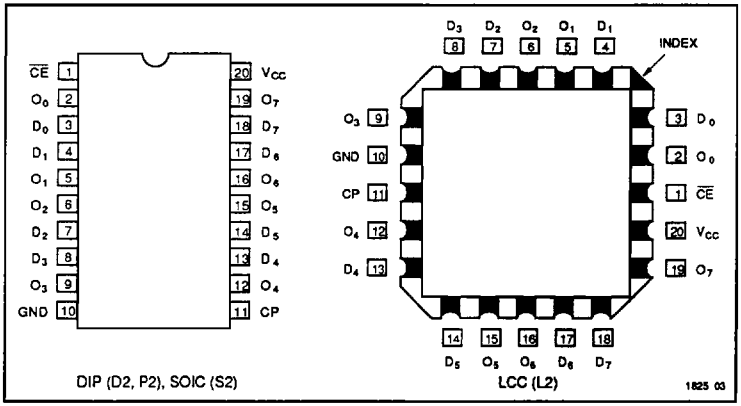
FUNCTIONAL BLOCK DIAGRAM



LOGIC SYMBOL



PIN CONFIGURATIONS



ABSOLUTE MAXIMUM RATINGS[1,2]

Symbol	Parameter	Value	Unit
T_{STG}	Storage Temperature	–65 to +150	°C
T_A	Ambient Temperature Under Bias	–65 to +135	°C
V_{CC}	V_{CC} Potential to Ground	–0.5 to +7.0	V
I_{IN}	Input Current	–30 to +5.0	mA

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Symbol	Parameter	Value	Unit
I_{OUTPUT}	Current Applied to Output	120	mA
V_{IN}	Input Voltage	–0.5 to V_{CC} + 0.5	V
V_{OUT}	Voltage Applied to Output	–0.5 to V_{CC} + 0.5	V

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Notes:

1. Operation beyond the limits set forth in the above table may impair the useful life of the device. Unless otherwise noted, these limits are over the operating free-air temperature range.
2. Unused inputs must always be connected to an appropriate logic voltage level, preferably either V_{CC} or ground.

RECOMMENDED OPERATING CONDITIONS

Free Air Ambient Temperature	Min	Max
Military	–55°C	+125°C
Commercial	0°C	+70°C

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Supply Voltage (V_{CC})	Min	Max
Military	+4.5V	+5.5V
Commercial	+4.75V	+5.25V

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DC ELECTRICAL CHARACTERISTICS (Over recommended operating conditions)

Symbol	Parameter		Min	Typ[1]	Max	Units	V_{CC}	Conditions
V_{IH}	Input HIGH Voltage		2.0			V		
V_{IL}	Input LOW Voltage				0.8	V		
V_H	Hysteresis			0.35		V		All inputs
V_{CD}	Input Clamp Diode Voltage			–0.7	–1.2	V	MIN	I_{IN} = –18mA
V_{OH}	Output HIGH Voltage	V_{CC} = 3V, V_{IN} = 0.2V, or V_{CC} – 0.2V	V_{CC} – 0.2	V_{CC}		V		I_{OH} = –32µA
		Military/Commercial (CMOS)	V_{CC} – 0.2	V_{CC}		V	MIN	I_{OH} = –300µA
		Military (TTL)	2.4	4.3		V	MIN	I_{OH} = –12mA
		Commercial (TTL)	2.4	4.3		V	MIN	I_{OH} = –15mA
V_{OL}	Output LOW Voltage	V_{CC} = 3V, V_{IN} = 0.2V, or V_{CC} – 0.2V		GND	0.2	V		I_{OL} = 300µA
		Military/Commercial (CMOS)		GND	0.2	V	MIN	I_{OL} = 300µA
		Military (TTL)		0.3	0.5	V	MIN	I_{OL} = 32mA
		Commercial (TTL)		0.3	0.5	V	MIN	I_{OL} = 48mA
		Commercial (TTL)		0.3	0.5	V	MIN	I_{OL} = 64mA
I_{IH}	Input HIGH Current				5	µA	MAX	V_{IN} = V_{CC}
I_{IL}	Input LOW Current				–5	µA	MAX	V_{IN} = GND
I_{IH}	Input HIGH Current[3]				5	µA	MAX	V_{IN} = 2.7V
I_{IL}	Input LOW Current[3]				–5	µA	MAX	V_{IN} = 0.5V
I_{OZH}	Off State I_{OUT} HIGH-Level Output Current				10	µA	MAX	V_{OUT} = V_{CC}
I_{OZL}	Off State I_{OUT} LOW-Level Output Current				–10	µA	MAX	V_{OUT} = GND
I_{OZH}	Off State I_{OUT} HIGH-Level Output Current[3]				10	µA	MAX	V_{OUT} = 2.7V
I_{OZL}	Off State I_{OUT} LOW-Level Output Current[3]				–10	µA	MAX	V_{OUT} = 0.5V
I_{OS}	Output Short Circuit Current[2]		–60	–120	–225	mA	MAX	V_{OUT} = 0.0V
C_{IN}	Input Capacitance[3]			5	10	pF	MAX	All inputs
C_{OUT}	Output Capacitance[3]			9	12	pF	MAX	All outputs

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Notes:

1. Typical limits are at V_{CC} = 5.0V, T_A = +25°C ambient.
2. Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high speed test apparatus and/or sample and hold techniques are preferable in order to minimize internal chip heating and more accurately reflect operational values. Otherwise prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{os} tests should be performed last.
3. This parameter is guaranteed but not tested.

DC CHARACTERISTICS (Over recommended operating conditions unless otherwise specified.)

Symbol	Parameter	Typ[1]	Max	Units	Conditions
I_{CC}	Quiescent Power Supply Current (CMOS inputs)	0.003	0.5	mA	V_{CC} = MAX, f_1 = 0, Outputs Open, $V_{IN} \leq 0.2V$ or $V_{IN} \geq V_{CC} - 0.2V$
ΔI_{CC}	Quiescent Power Supply Current (TTL inputs)	0.5	2.0	mA	V_{CC} = MAX, V_{IN} = 3.4V[2], f_1 = 0, Outputs Open
I_{CCD}	Dynamic Power Supply Current[3]	0.15	0.25	mA/ mHz	V_{CC} = MAX, One Bit Toggling, 50% Duty Cycle, Outputs Open, $\overline{CE}$ = GND, $V_{IN} \leq 0.2V$ or $V_{IN} \geq V_{CC} - 0.2V$
I_C	Total Power Supply Current[5]	1.7	4.0	mA	V_{CC} = MAX, f_0 = 10MHz, 50% Duty Cycle, Outputs Open, One Bit Toggling at f_1 = 5MHz, $\overline{CE}$ = GND, $V_{IN} \leq 0.2V$ or $V_{IN} \geq V_{CC} - 0.2V$
		2.2	6.0	mA	V_{CC} = MAX, f_0 = 10MHz, 50% Duty Cycle, Outputs Open, One Bit Toggling at f_1 = 5MHz, $\overline{CE}$ = GND, V_{IN} = 3.4V or V_{IN} = GND
		4.0	7.8[4]	mA	V_{CC} = MAX, f_0 = 10MHz, 50% Duty Cycle, Outputs Open, Eight Bits Toggling at f_1 = 2.5MHz, $\overline{CE}$ = GND, $V_{IN} \leq 0.2V$ or $V_{IN} \geq V_{CC} - 0.2V$
		6.2	16.8[4]	mA	V_{CC} = MAX, f_0 = 10MHz, 50% Duty Cycle, Outputs Open, Eight Bits Toggling at f_1 = 2.5MHz, $\overline{CE}$ = GND, V_{IN} = 3.4V or V_{IN} = GND

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Notes:

1. Typical values are at V_{CC} = 5.0V, +25°C ambient.
2. Per TTL driven input (V_{IN} = 3.4V); all other inputs at V_{CC} or GND.
3. This parameter is not directly testable, but is derived for use in Total Power Supply calculations.
4. Values for these conditions are examples of the I_{CC} formula. These limits are guaranteed but not tested.
5. $I_C = I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC}$
   $I_C = I_{CC} + \Delta I_{CC} D_H N_T + I_{CCD}(f_0/2 + f_1 N_1)$
   I_{CC} = Quiescent Current with CMOS input levels
   ΔI_{CC} = Power Supply Current for a TTL High Input (V_{IN} = 3.4V)
   D_H = Duty Cycle for TTL Inputs High
   N_T = Number of TTL Inputs at D_H
   I_{CCD} = Dynamic Current Caused by an Input Transition Pair (HLH or LHL)
   f_0 = Clock Frequency for Register Devices (Zero for Non-Register Devices)
   f_1 = Input Frequency
   N_1 = Number of Inputs at f_1
   All currents are in milliamps and all frequencies are in megahertz.

TRUTH TABLE

Operating Mode	Inputs			Outputs
	CP	$\overline{CE}$	D	O
Load "1"	⌐‾	l	h	H
Load "0"	⌐‾	l	l	L
Hold (Do Nothing)	⌐‾	h	X	No Change
	X	H	X	No Change

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H = HIGH Voltage Level
h = HIGH Voltage Level one setup time prior to the LOW-to-HIGH Clock Transition
L = LOW Voltage Level
l = LOW Voltage Level one setup time prior to the LOW-to-HIGH Clock Transition
X = Immaterial
⌐‾ = LOW-to-HIGH Clock Transition

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AC CHARACTERISTICS

Symbol	Parameter	'FCT377				'FCT377A				'FCT377C				Units	Fig. No.
		MIL		COM'L		MIL		COM'L		MIL		COM'L			
		Min.[1]	Max.	Min.[1]	Max.	Min.[1]	Max.	Min.[1]	Max.	Min.[1]	Max	Min.[1]	Max.		
t_{PLH} t_{PHL}	Propagation Delay Clock to Output	2.0	15.0	2.0	13.0	2.0	8.3	2.0	7.2	2.0	5.5	2.0	5.2	ns	1, 5

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Note: AC Characteristics guaranteed with C_L = 50pF as shown in Figure 1.

AC OPERATING REQUIREMENTS

Symbol	Parameter	'FCT377				'FCT377A				'FCT377C				Units	Fig. No.
		MIL		COM'L		MIL		COM'L		MIL		COM'L			
		Min.[1]	Max.	Min.[1]	Max.	Min.[1]	Max.	Min.[1]	Max.	Min.[1]	Max	Min.[1]	Max.		
t_s(H)	Setup Time, HIGH or Low Data to CP	3.0	—	2.5	—	2.0	—	2.0	—	2.0	—	2.0	—	ns	4
t_h(H) t_h(L)	Hold Time, HIGH or LOW Data to CP	2.5	—	2.0	—	1.5	—	1.5	—	1.5	—	1.5	—	ns	4
t_w(H) t_w(L)	Setup Time, HIGH or LOW $\overline{CE}$ to CP	3.5	—	3.5	—	3.5	—	3.5	—	3.5	—	3.5	—	ns	5
t_w(H) t_w(L)	Hold Time, HIGH or LOW $\overline{CE}$ to CP	1.5	—	1.5	—	1.5	—	1.5	—	1.5	—	1.5	—	ns	6
t_w(L)	Clock Pulse Width LOW	7.0	—	7.0	—	7.0	—	6.0	—	7.0	—	6.0	—	ns	6

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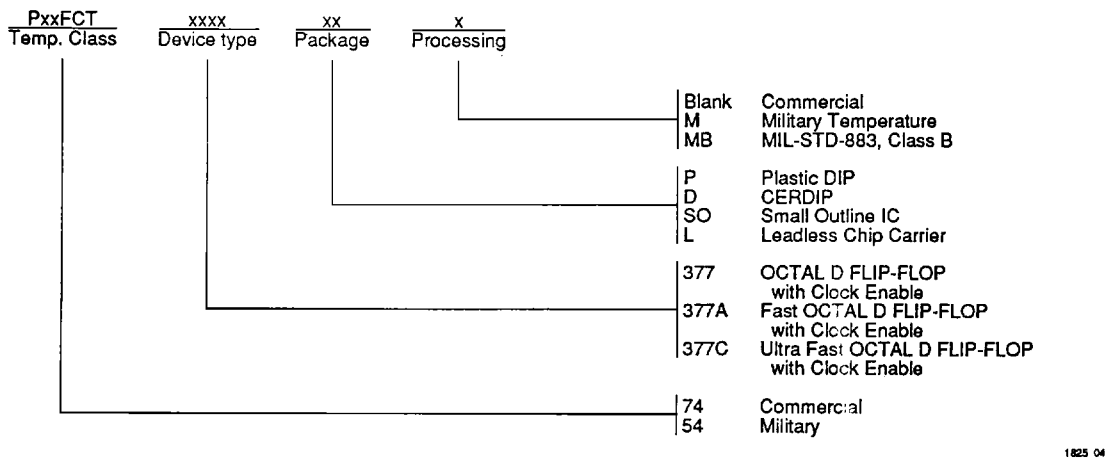
Note:
1. Minimum limits are guaranteed but not tested on Propagation Delays.

ORDERING INFORMATION



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